

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Atty. Dkt. No. 5298-04500 PM00026

Inventor(s):

Gabriel Li; Kenelm G. D. Murray; Jose Arreola; Shahin Sharifzadeh;

K. Nirmal Ratnakumar

Title:

BURIED LAYER SUBSTRATE

ISOLATION IN INTEGRATED

CIRCUITS

CERTIFICATE OF EXPRESS MAIL UNDER 37 C.F.R. § 1.10

"Express Mail" mailing label no. <u>EL822012736US</u>
Date of Deposit: <u>May 4, 2001</u>

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Derrick Brown

UTILITY PATENT APPLICATION TRANSMITTAL

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(For new non-provisional applications under 37 CFR § 1.53(b))

Enclosed are the following items:

1. A fee authorization for the amount of \$934.00; the filing fee is calculated as shown below.

Total Claims	28	-20 =	8	x \$18.00 =	\$144.00
Independent Claims	4	-3 =	1	x \$80.00 =	\$80.00
Multiple Dependent Claims				Fee:	
	·····			Basic Fee:	\$ 710.00
				Total:	\$ 934.00

- 2. Request & Certification under 35 U.S.C. 122(b)(2)(B)(i).
- 3. Patent application which includes: 16 pg. disclosure; 5 pg. claims (1-28); 1 pg. abstract.
- 4. Formal drawings of Figs. 1 8 on 6 sheets.
- 5. Newly executed Declaration/Power of Attorney.
- 6. Newly executed Assignment w/cover sheet.
- 7. Return receipt postcard(s).

Respectfully submitted,

Kevin L. Daffer

Reg. No. 34,146 Attorney for Applicants

Conley, Rose & Tayon P.O. Box 398 Austin, TX 78767-0398 Date: May 4, 2001

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Derrick Brown

FEE AUTHORIZATION

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Assistant Commissioner for Patents Washington, D.C. 20231

The Commissioner is hereby authorized to charge the following fee to Conley, Rose & Tayon, P.C. deposit account no. 50-1505/5298-04500*. A duplicate of this page is enclosed.

Item:

Filing fee

Amount:

\$934.00

Atty. Dkt. No.

5298-04500

Respectfully submitted,

Kevin L. Daffer Reg. No. 34,146

Attorney for Applicants

Conley, Rose & Tayon P.O. Box 398 Austin, TX 78767-0398

Date: May 4, 2001

^{*} If the above listed account is found to have insufficient funds, the Commissioner is authorized to charge Conley, Rose & Tayon, P.C. deposit account no. 50-1623/5298-04500.

CERTIFICATE OF EXPRESS MAIL UNDER 37 C.F.R. §1.10

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> Assistant Commissioner for Patents Box Patent Application Washington, DC 20231

> > Derrick Brown

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

Atty Docket Number:	5298-04500		
First Named Inventor:	Gabriel Li et al.		

BURIED LAYER SUBSTRATE ISOLATION IN INTEGRATED CIRCUITS

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

May 4, 2001 Date

Kevin L. Daffer, Reg. No. 34,146

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).